D1FJ8A

Schottky Barrier Diodes

80V, 3A

Feature

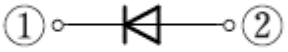
- Small SMD
- High Recovery Speed
- Available for automotive use
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): 1F
Package (JEDEC Code): DO-214AC



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperrature	Tstg		-55 to 150	℃
Junction temperature	Tj		-55 to 150	℃
Repetitive peak reverse voltage	V_{RRM}		80	V
Average forward current	I_F(AV)	50Hz sine wave, Resistance load, Tc=100°C ※	3	A
Average forward current	I_F(AV)	50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=30°C ※	2.1	A
Surge forward current	I_{FSM}	50Hz sine wave, Non-repetitive, 1cycle, Peak value, Tj=25°C	30	A

※ ：See the original Specifications

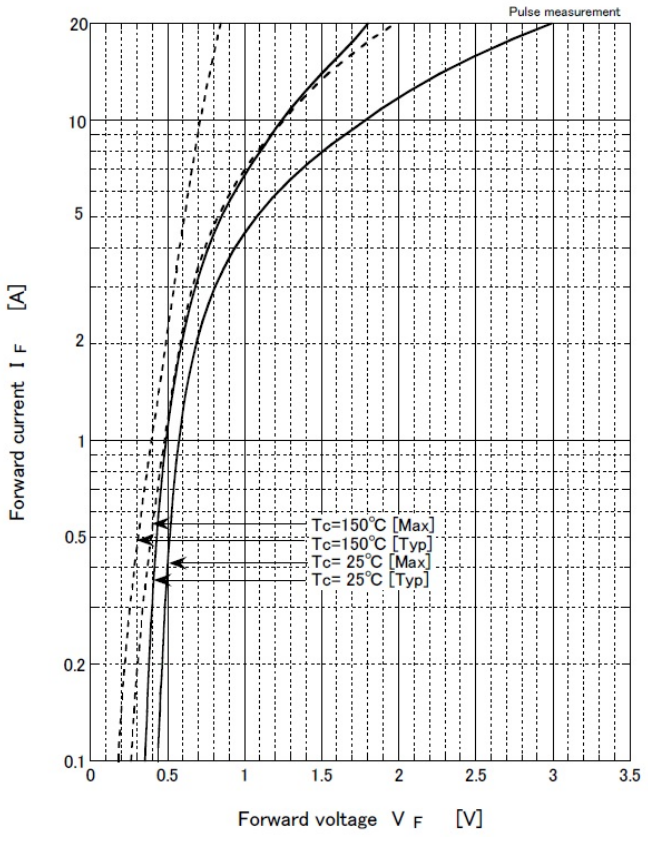
Electrical Characteristics (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	V_F	IF=3A, Pulse measurement			0.74	V
Reverse current	I_R	VR=80V, Pulse measurement			0.4	mA
Total capacitance	Ct	f=1MHz, VR=10V		70		pF
Thermal resistance	Rth(j-c)	Junction to case, On glass-epoxy substrate ※			16	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, On glass-epoxy substrate ※			65	°C/W

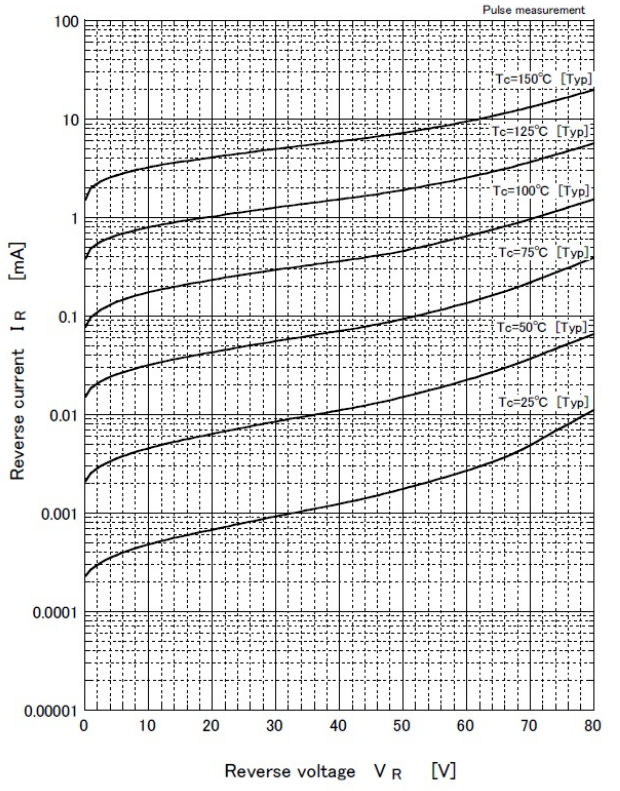
※ ：See the original Specifications

CHARACTERISTIC DIAGRAMS

Forward voltage

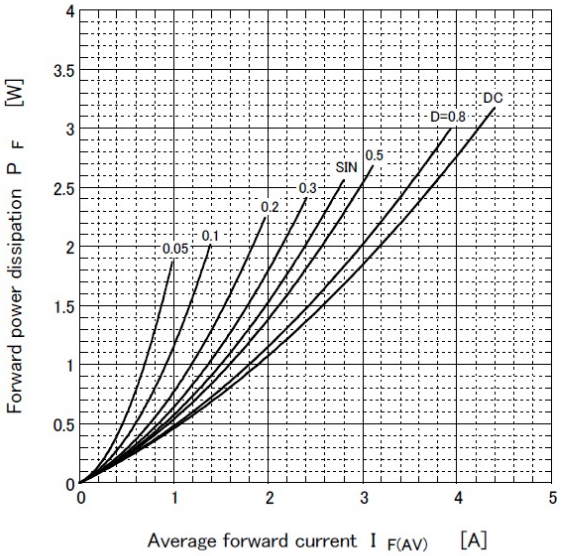


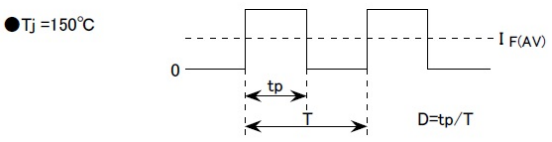
Reverse current



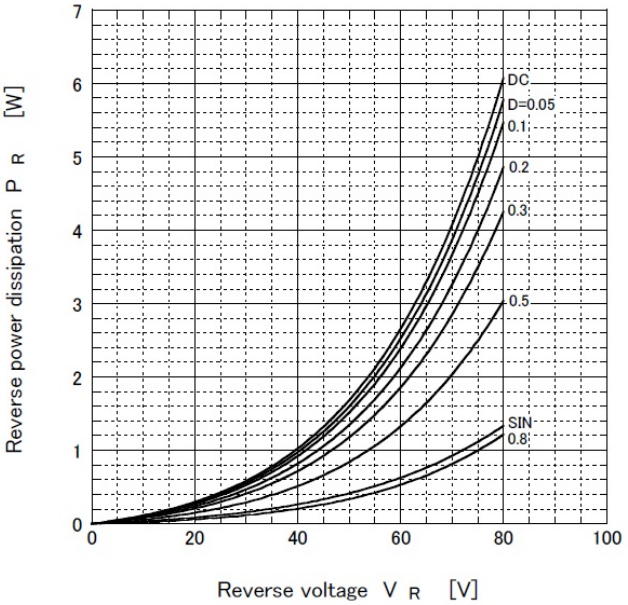
Note: The above characteristics curves are presented for reference only and not guaranteed by production test,unless otherwise noted.

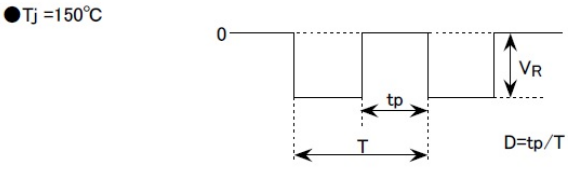
Forward power dissipation



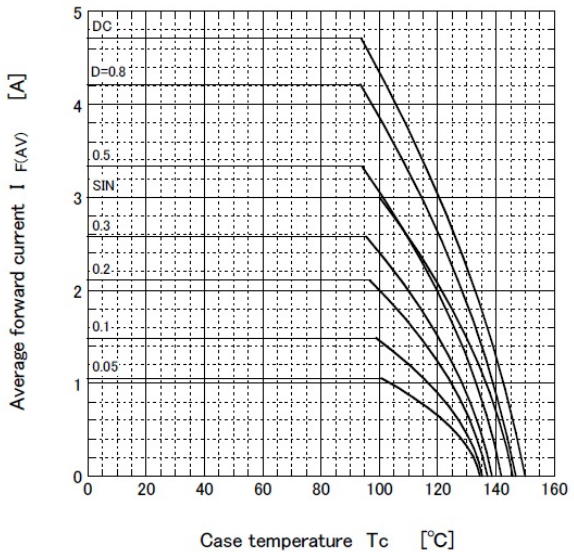


Reverse power dissipation





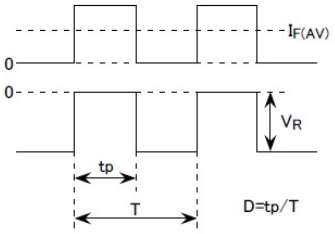
Derating curve



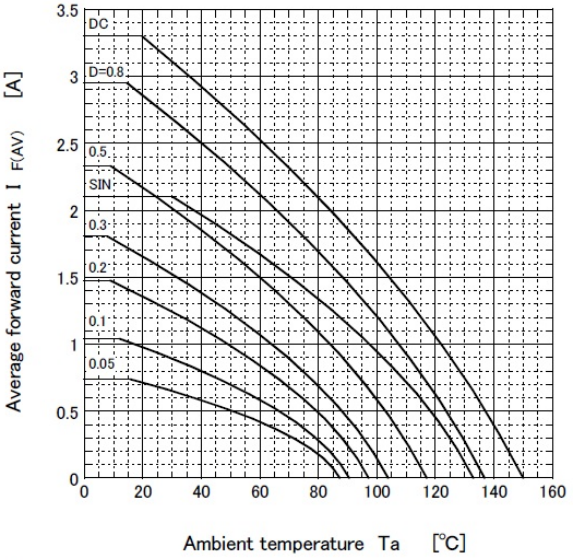
●V_R = 40V
R-load
Free in air

●Substrate detail

Type	Glass-epoxy
Size	2 inch²
Thickness	1mm
Conductor thickness	35 μ m
Pattern area	2274mm²



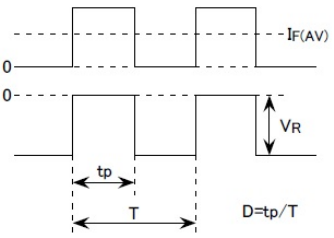
Derating curve



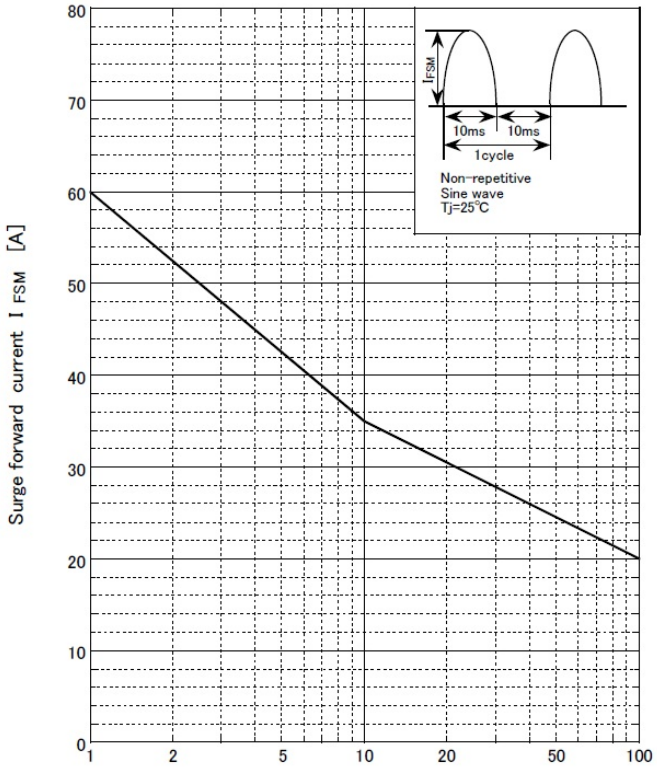
●V_R = 40V
R-load
Free in air

●Substrate detail

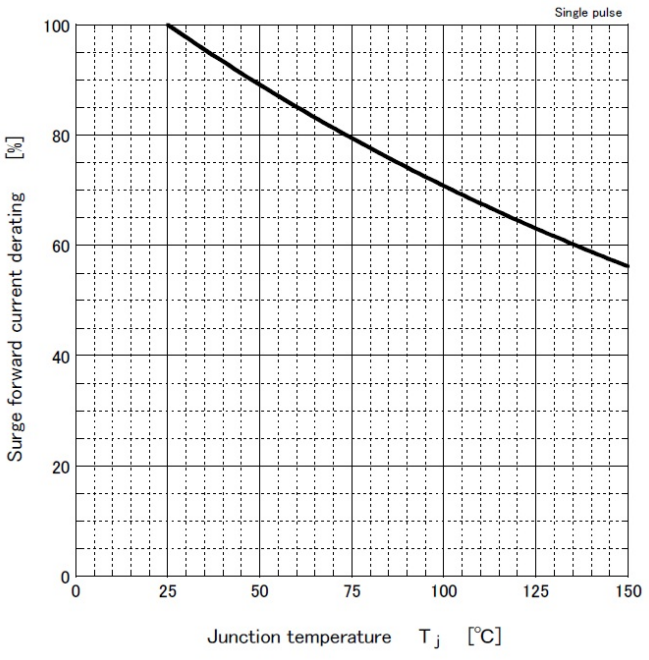
Type	Glass-epoxy
Size	2 inch²
Thickness	1mm
Conductor thickness	35 μ m
Pattern area	2274mm²

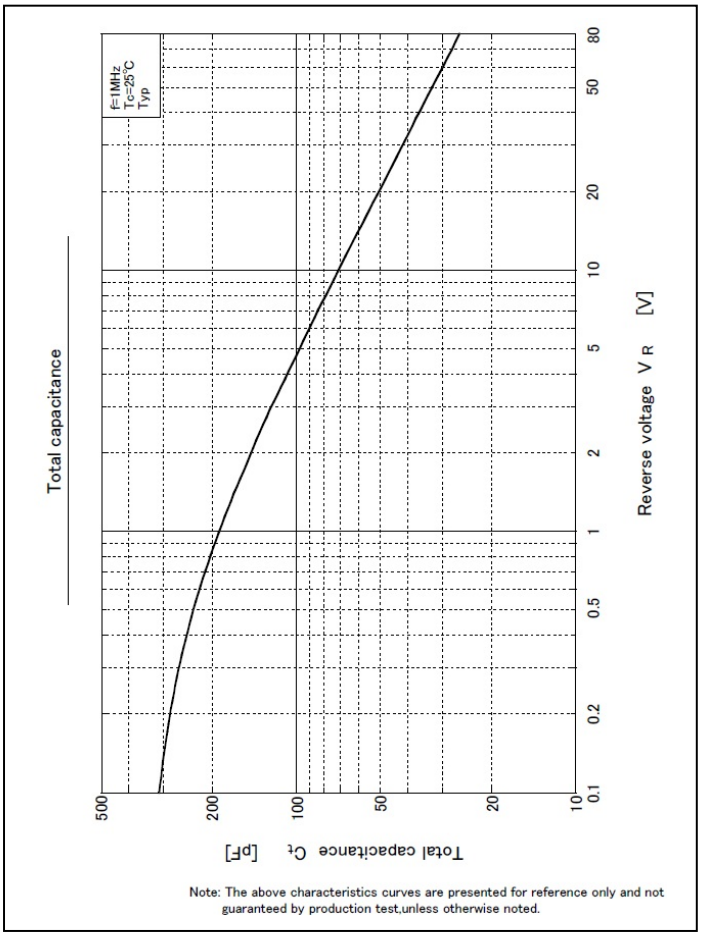


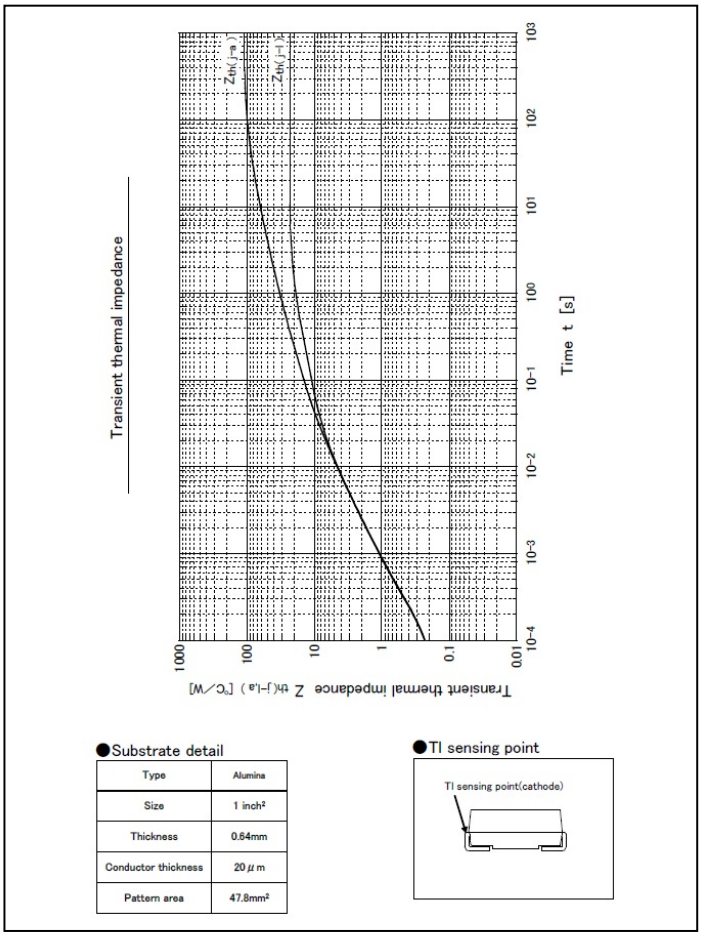
Surge forward current capability

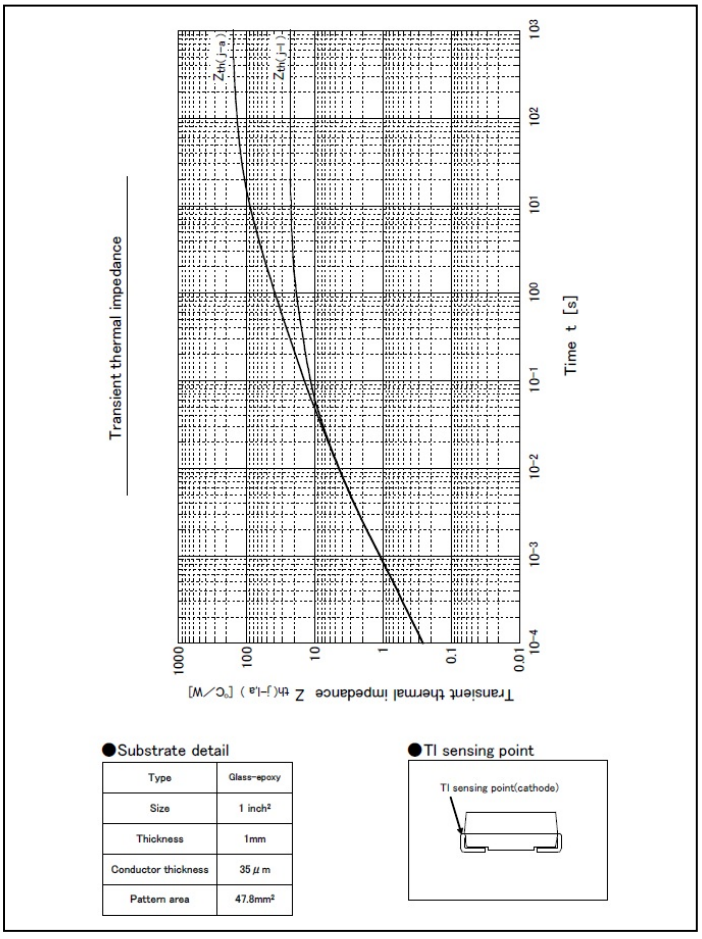


Surge forward current derating vs Junction temperature




Total capacitance
f=1MHz
Tc=25°C
Typ
Reverse voltage V R [V]
Total capacitance C t [pF]
Note: The above characteristics curves are presented for reference only and not guaranteed by production test,unless otherwise noted.


Transient thermal impedance
Time t [s]
Transient thermal impedance Z th(j-a) [°C/W]
Zth(j-a)
Zth(j-c)
●Substrate detail
Type Alumina
Size 1 inch²
Thickness 0.64mm
Conductor thickness 20 μ m
Pattern area 47.8mm²
●TI sensing point
TI sensing point(cathode)


Transient thermal impedance
Time t [s]
Transient thermal impedance Z th(j-a) [°C/W]
Zth(j-a)
Zth(j-c)
●Substrate detail
Type Glass-epoxy
Size 1 inch²
Thickness 1mm
Conductor thickness 35 μ m
Pattern area 47.8mm²
●TI sensing point
TI sensing point(cathode)

Outline Dimensions

unit:mm

B3

JEDEC Code	DO-214AC
JEITA Code	–
House Name	1F, CF

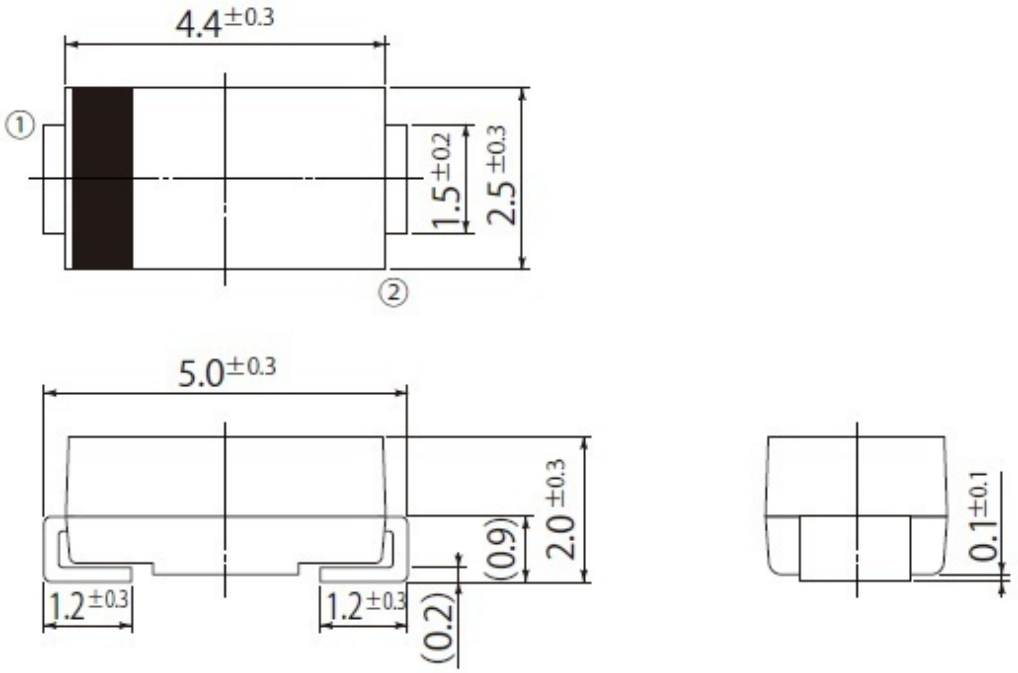
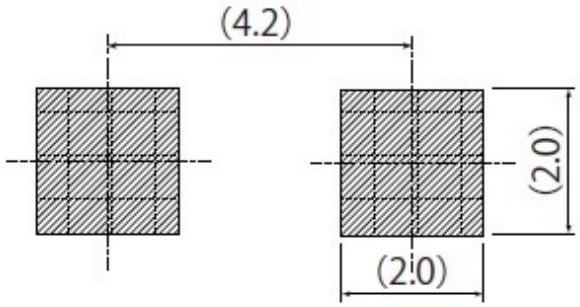


Fig. B3-1 ① ②



Referential Soldering Pad

- Optimize soldering pad to the board design and soldering condition.

- The content specified herein is subject to change for improvement without notice.
- If you wish to use any such products, please be sure to refer to the specifications.

U182-1 (2026.08)

Notes

1. If you wish to use any such product, please be sure to refer to the specifications issued by Shindengen.
2. All products described or contained herein are designed with a quality level intended for use in standard applications requiring an ordinary level of reliability. If these products are to be used in equipment or devices for special or specific applications requiring an extremely high grade of quality or reliability in which failures or malfunctions of products may directly affect human life or health, a local Shindengen office must be contacted in advance to confirm that the intended use of the product is appropriate. Shindengen products are grouped into the following three applications according the quality grade.

   【Standard applications】
   Computers, office automation and other office equipment, communication terminals, test and measurement equipment, audio/visual equipment, amusement equipment, consumer electronics, machine tools, personal electronic equipment, industrial equipment, etc.
   【Special applications】
   Transportation equipment (vehicles, ships, etc.), trunk-line communication equipment, traffic signal control systems, anti-disaster/crime systems, safety equipment, medical equipment, etc.
   【Specific applications】
   Nuclear reactor control systems, aircraft, aerospace equipment, submarine repeaters, life support equipment and systems, etc.
3. Although Shindengen continuously endeavors to enhance the quality and reliability of its products, customers are advised to consider and take safety measures in their design, such as redundancy, fire containment and anti-failure, so that personal injury, fires, or societal damages can be prevented.
4. Please note that all information described or contained herein is subject to change without notice due to product upgrades and other reasons. When buying Shindengen products, please contact the Company’s offices or distributors to obtain the latest information.
5. Shindengen shall not bear any responsibility with regards to damages or infringement of any third-party patent rights and other intellectual property rights incurred due to the use of information on this website.
6. The information and materials on this website neither warrant the use of Shindengen's or any third party’s patent rights and other intellectual property rights, nor grant license to such rights.
7. In the event that any product described or contained herein falls under the category of strategic products controlled under the Foreign Exchange and Foreign Trade Control Law of Japan, exporting of such products shall require an export license from the Japanese government in accordance with the above law.
8. No reprinting or reproduction of the materials on this website, either in whole or in part, is permitted without proper authorization from Shindengen.